

IPD068N10N3 G-VB Datasheet N-Channel 100-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|-----------------------------------|--------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | | | |
| 100 | 0.0085 at V _{GS} = 10 V | 85 | | | |
| | 0.0105 at V _{GS} = 4.5 V | 70 | | | |

FEATURES

- TrenchFET® Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

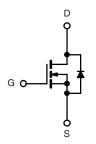


APPLICATIONS

- Primary Side Switch
- Isolated DC/DC Converter



TO-252



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | | |
|--|-------------------------|-----------------------------------|-----------------|-----|--|--|
| Parameter | Symbol | Limit | Unit | | | |
| Drain-Source Voltage | V _{DS} | 100 | V | | | |
| Gate-Source Voltage | V _{GS} | ± 20 | V | | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C | I _D | 85 | | | |
| | T _C = 125 °C | | 75 ^a | ^ | | |
| Pulsed Drain Current | I _{DM} | 300 | Α | | | |
| Avalanche Current | L = 0.1 mH | I _{AS} | 75 | | | |
| Single Pulse Avalanche Energy ^b | L = 0.1 IIII1 | E _{AS} | 280 | mJ | | |
| Maximum Power Dissipation ^b | T _C = 25 °C | P _D | 176 | W | | |
| | T _A = 25 °C | ט י | 3.75 | V V | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|----------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 40 | 50 | °C/W | |
| Maximum Junction-to-Case | - Steady State | R _{thJC} | 0.85 | 1.1 | C/VV | |

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|----------------------------|---|--------|--------|-------|-------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$ 100 $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ 1 | | | | V | |
| Gate-Threshold Voltage | V _{GS(th)} | | | | 4 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | μΑ | |
| Zero Gate Voltage Drain Current | | V _{DS} = 80 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | | |
| | | V _{DS} = 80 V, V _{GS} = 0 V, T _J = 175°C | | | 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 50 | | | Α | |
| | | V _{GS} = 10 V, I _D = 20 A | 0.0085 | | | | |
| | D | V _{GS} = 4.5 V, I _D = 20 A | | 0.0105 | | Ω | |
| Drain-Source On-State Resistance ^a | H _{DS(on)} | V _{GS} = 10 V, I _D =20 A, T _J = 125 °C | | 0.017 | | | |
| | | $V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 175 ^{\circ}\text{C}$ | | 0.022 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 20A | 25 | | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 4000 | | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 565 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 205 | | | |
| Total Gate Charge ^c | Qg | | | 105 | 160 | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 45 \text{ A}$ | | 17 | | nC | |
| Gate-Drain Charge ^c | Q _{gd} | | | 23 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 12 | 25 | | |
| Rise Time ^c | t _r | $V_{DD} = 20 \text{ V}, R_{L} = 0.6 \Omega$ | | 90 | 135 | | |
| Turn-Off DelayTime ^c | t _{d(off)} | $I_D \cong 45 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$ | | 55 | 85 | ns ns | |
| Fall Time ^c | t _f | | | 130 | 195 | | |
| Source-Drain Diode Ratings and Char | acteristics T _C | = 25 °C ^b | | | | | |
| Continuous Current | I _S | | | | 85 | ^ | |
| Pulsed Current | I _{SM} | | | | 140 | Α | |
| Forward Voltage ^a | V _{SD} | I _F = 45 A, V _{GS} = 0 V | | 1.0 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 85 | 140 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 50 A, dl/dt = 100 A/μs | | 4.5 | 7 | Α | |
| Reverse Recovery Charge | Q _{rr} | | | 0.17 | 0.35 | μС | |

Notes:

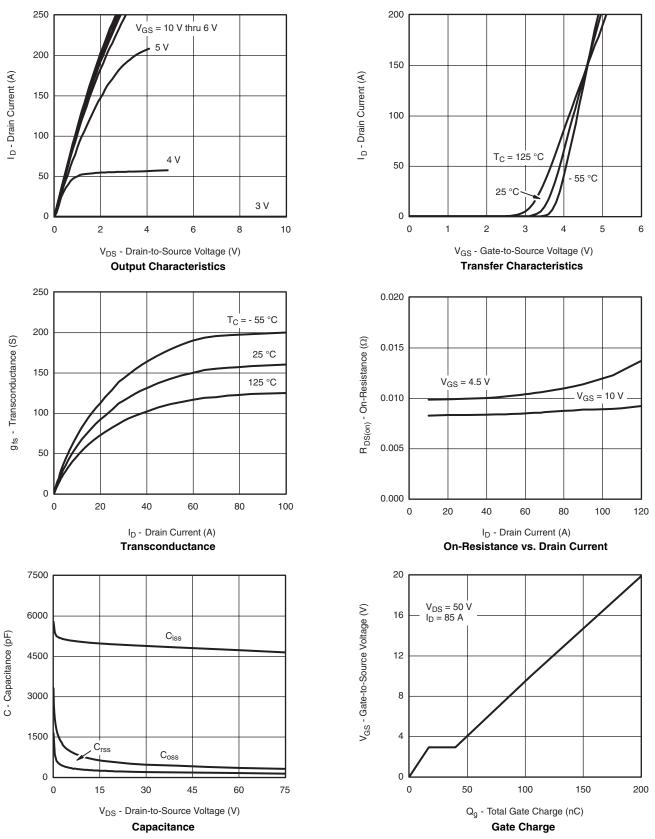
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- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

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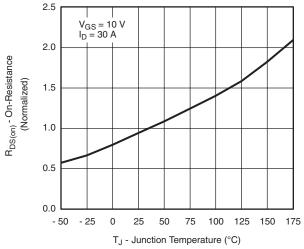


TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}C$, unless otherwise noted

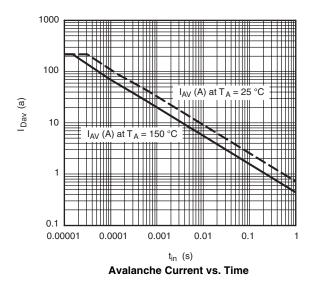




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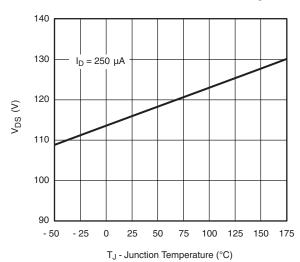


On-Resistance vs. Junction Temperature



T_J = 150 °C T_J = 25 °C T_J

Source-Drain Diode Forward Voltage

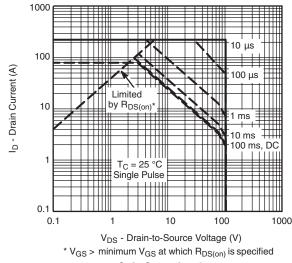


T_J - Drain-Source Breakdown vs. Junction-Temperature



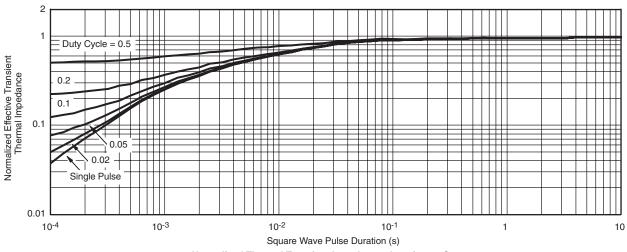
THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature

Safe Operating Area



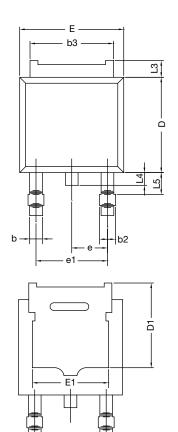
Normalized Thermal Transient Impedance, Junction-to-Case

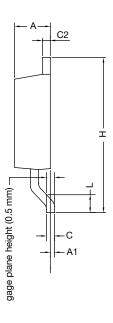
服务热线:400-655-8788

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TO-252AA CASE OUTLINE





| | MILLIMETERS | | INC | HES | | |
|---------------------------------|-------------|-------|-----------------|-------|--|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | | |
| Α | 2.18 | 2.38 | 0.086 | 0.094 | | |
| A1 | - | 0.127 | - | 0.005 | | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | | |
| D1 | 5.21 | - | 0.205 | - | | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | | |
| E1 | 4.32 | - | 0.170 | - | | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | | |
| е | 2.28 BSC | | 3 BSC 0.090 BSC | | | |
| e1 | 4.56 BSC | | 0.180 | BSC | | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | | |
| L4 | - | 1.02 | - | 0.040 | | |
| L5 | 1.14 | 1.52 | 0.045 | 0.060 | | |
| ECN: X12-0247-Rev. M, 24-Dec-12 | | | | | | |

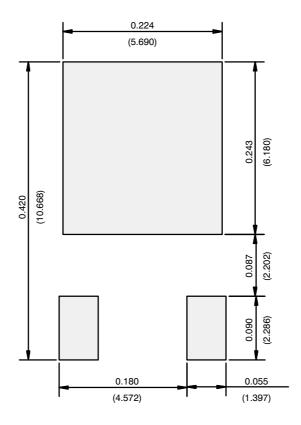
ECN: X12-0247-Rev. M, 24-Dec-1 DWG: 5347

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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